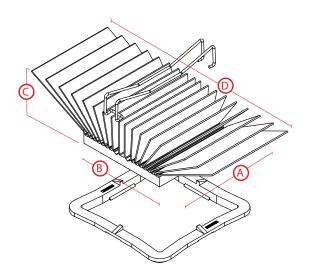


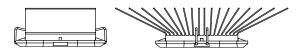
Ultra High Performance BGA Cooling Solutions w/ maxiGRIP™ Attachment

ATS PART # ATS-50230P-C2-R0

Features & Benefits

- » maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- » maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB
- » Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock and Unpackaged Drop Testing standards
- » Comes preassembled with high performance, phase changing, thermal interface material
- » Designed for standard height components from 3 to 4.5mm





*Image above is for illustration purposes only

Therma	l Performance
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AIR VELOCITY		THERMAL RESISTANCE		
FT/MIN	M/S	°C/W (UNDUCTED FLOW)	°C/W (DUCTED FLOW)	
200	1.0	5.1	4.1	
300	1.5	4.2		
400	2.0	3.6		
500	2.5	3.3		
600	3.0	3		
700	3.5	2.8		
800	4.0	2.6		

Product Details

DIMENSION A	DIMENSION B	DIMENSION C	DIMENSION D	INTERFACE MATERIAL	FINISH
23 mm	23 mm	17.5 mm	41.5 mm	SAINT-GOBAIN C1100F	BLUE-ANODIZED

NOTES

- WWW Dimension Car heat sink height from bottom of the base to the top of the fin field.
 - ATS-50230P-C1-R0 is a substitute item available utilizing an equivalent phase change material (Chomerics T766).
- Thermal performance data are provided for reference only. Actual performance may vary by application.
- ATS reserves the right to update or change its products without notice to improve the design or performance.
- Optional maxiGRIP™ Installation/Removal Tool Set P/N: MGT230
- 6) Contact ATS to learn about custom options available.



For more information, to find a distributor or to place an order, visit www.qats.com or call: 781.769.2800 (North America); +31 (0) 3569 84715 (Europe).